



## 30V P-Channel Trench Power MOSFET

### General Description

The SJJ30P015 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as -4.5V. This device is suitable for use as a wide variety of applications.

### Features

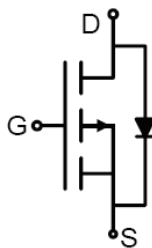
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handling capability
- Lead free product is acquired

### Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

### Key Performance Parameters

Parameter	Value	Unit
$V_{DS}$	-30	V
$R_{DS(ON\_TYP)}$	1.6	m $\Omega$
$I_D$	-295	A
$Q_G$	130	nC



Schematic Diagram



TO-263 top view



### Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJJ30P015	SJJ30P015	TO-263	Tape	\	\	800 Pcs

Table 1. Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0V$ )	-30	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0V$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_C=25^\circ\text{C}$ )	-295	A
	Drain Current-Continuous( $T_C=100^\circ\text{C}$ )	-186	A
$I_{DM} \text{ (pluse)}$	Drain Current-Continuous@ Current-Pulsed (Note 1)	-1180	A
$P_D$	Maximum Power Dissipation( $T_C=25^\circ\text{C}$ )	278	W
	Maximum Power Dissipation( $T_C=100^\circ\text{C}$ )	111	W
$E_{AS}$	Avalanche energy (Note 2)	1056	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	$^\circ\text{C}$

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.45	$^\circ\text{C/W}$



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**Table 3. Electrical Characteristics ( $T_J=25^{\circ}\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-30			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V T <sub>J</sub> =25℃			-1	μA
		V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V T <sub>J</sub> =125℃			-100	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA	-1		-2.5	V
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =-5V, I <sub>D</sub> =-20A		63		S
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =-10V, I <sub>D</sub> =-20A		1.6	2	mΩ
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-20A		2	2.7	mΩ
Dynamic Characteristics						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V, f=1.0MHz		25100		pF
C <sub>oss</sub>	Output Capacitance			2650		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			2400		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz		0.86		Ω
Switching Parameters						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-15V, R <sub>L</sub> =0.75Ω, R <sub>GEN</sub> =3Ω		13		nS
t <sub>r</sub>	Turn-on Rise Time			32		nS
t <sub>d(off)</sub>	Turn-Off Delay Time			27		nS
t <sub>f</sub>	Turn-Off Fall Time			9		nS
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-15V, I <sub>D</sub> =-20A		130		nC
Q <sub>gs</sub>	Gate-Source Charge			12		nC
Q <sub>gd</sub>	Gate-Drain Charge			31		nC
Source-Drain Diode Characteristics						
I <sub>SD</sub>	Source-Drain Current (Body Diode)				-295	A
V <sub>SD</sub>	Forward on Voltage (Note 3)	V <sub>GS</sub> =0V, I <sub>S</sub> =-20A			-1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> =-20A, di/dt=-100A/μs		30		ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> =-20A, di/dt=-100A/μs		40		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

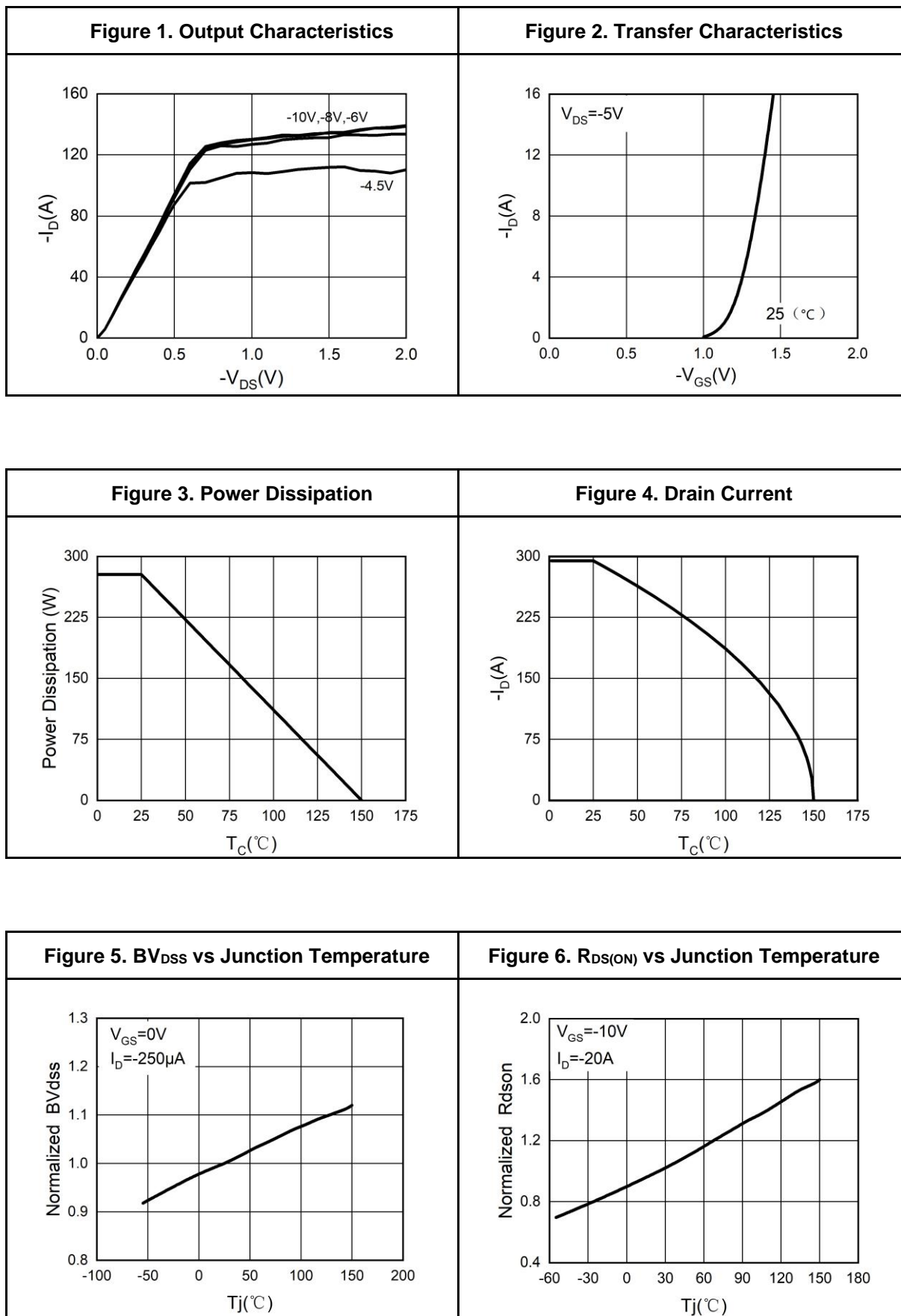
Notes 2.EAS condition:  $T_J=25^{\circ}\text{C}, V_{DD}=-30V, V_G=-10V, R_g=25\Omega, L=0.5\text{mH}$ .

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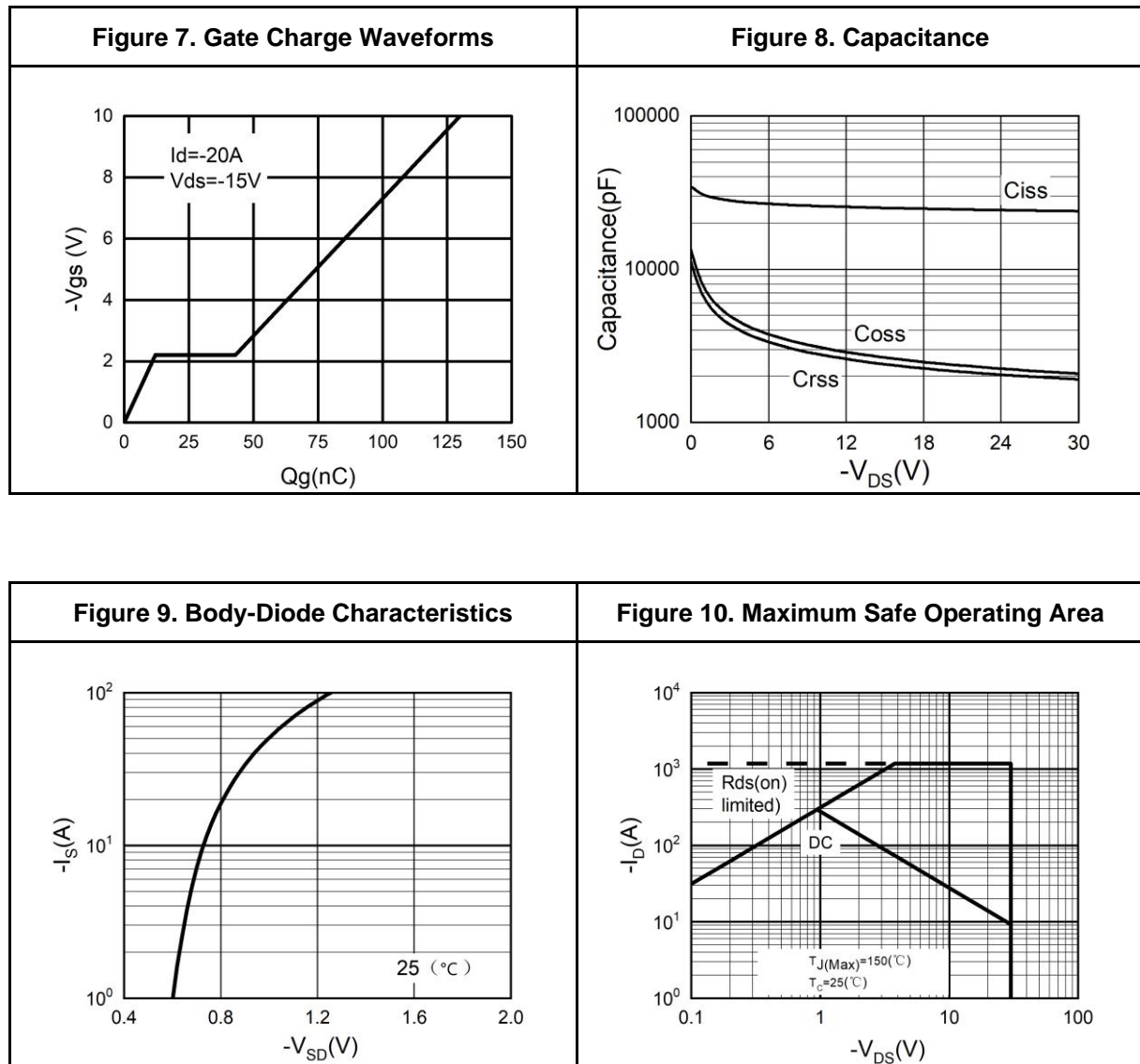
### Typical Electrical And Thermal Characteristics (Curves)





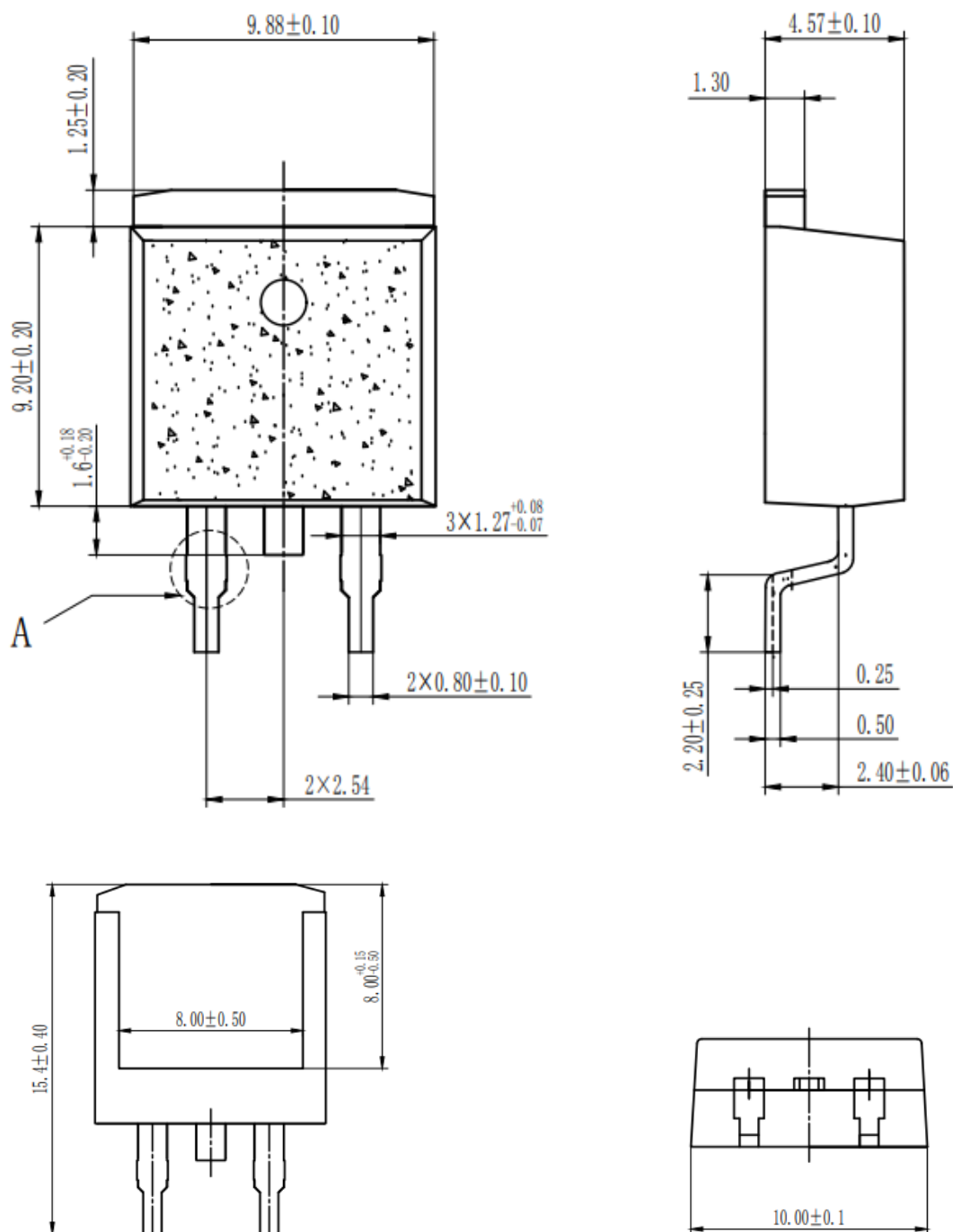
## 30V P-Channel Trench Power MOSFET

### Typical Electrical And Thermal Characteristics (Curves)





TO-263 Package Information





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